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13. ABSTRACT (Maximum 200 words)  This research entailed the development of a unified methodology for integrated circuit, printed antenna, and printed antenna array design. Microwave antenna performance optimization may be achieved by shaping the antenna properly, as well as with the correct antenna excitation design. This final report presents a methodology for the design of 3-D microstrip fed arbitrarily shaped aperture and patch antennas in a multilayered medium. It includes the design of antenna excitation either through parasitic coupling, or through a via hole transition from a microstrip line. Comparison of numerical results with experimental data shows good agreement. A methodology for the design of multiple via-hole and air-bridge transitions of arbitrary shape in multilayered multiport microstrip circuits is also presented. Application of multiple via holes to the design of microstrip filters and other devices will be discussed. To properly describe the current along the vertical post, the simple pulse function with triangular cross section is used in the moment method analysis. Circularly and rectangularly shaped vertical transitions are analyzed for several practical applications. Comparisons of numerical results with experimental and available data again shows good agreement.				
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## 1. Research Outline

With the merits of low profile, low cost and compact size, microstrip elements are useful for applications in microwave antennas and antenna arrays. They can be used as the radiating element of a MIC/MMIC design in aircraft/satellite communications [1], in missile and rocket [2] antenna systems, as well as many other applications. Due to substantial improvements in fabrication technologies, microstrip elements can now be designed as useful antennas well into the millimeter-wave range. Compact size and large scale integration of electronic devices have been driving the trend towards a multilayered interconnection system. Via holes and other vertical shunt posts, such as bond wires and air bridges, are increasingly important in microwave integrated circuit/monolithic microwave integrated circuit (MIC/MMIC) design. Via holes are used to connect parallel microstrip lines for signal transmission between different layers. Vias can be modeled by lumped circuit elements at lower frequencies. The equivalent circuits of vias based on the quasi-static analysis have been investigated by Wang *et.al.* [27],[28]. At higher frequencies the propagation characteristics of via holes have a stronger electromagnetic effect on the performance of devices, therefore, rigorous analysis is necessary to predict frequency response correctly.

A variety of full-wave design analyses have been reported over the past two decades [3] [4]. These techniques include finite-difference time-domain (FDTD) method, finite-element method (FEM), the method of lines (MOL), transmission line matrix (TLM), and integral equation (IE) formulations. Using reciprocity, Pozar [5] analyzed microstrip fed rectangular aperture and aperture coupled patch antennas. The most rigorous and general method is the integral equation formulation. It is based on the electric and magnetic-field integral equations (EFIE/MFIE) governed by the unknown current distributions on the microstrips and apertures. However, the EFIE/MFIE formulations suffer from either the highly singular behavior in the spatial domain, or the long computation time in the spectral domain. A modification of the EFIE/MFIE named the mixed-potential integral equation (MPIE), is formulated in the spatial domain. It was first introduced by Harrington [6], and has been extensively used for the analysis of wire antennas. Mosig [3],[7] and Michalski [8],[9] have applied MPIE models to planar microstrips. Chen *et. al.* [10] has applied the MPIE to model apertures in a ground plane.

In this research, a combined MPIE-EFIE formulation was developed to solve 3-D multilayered circuits with arbitrary shape. First, the spectral-domain multi-layered Green's function was derived analytically by applying the wave matrix method [11] [12]. A hybrid complex image method (CIM) [13]-[16] and an efficient numerical integration algorithm [17] were implemented to evaluate the spatial-domain Greens' function through the Sommerfeld-type integral. Triangular basis functions [18] were used to expand the electric current distributions on the microstrip line, patch antenna, and the fictitious magnetic current distribution over the aperture. The simple pulse function with triangular cross section was adopted here to model the vertical electric current along the vias. The method of moments was then applied to solve the integral equation pertinent to the modeling of our problem. The MPIE formulation was used to evaluate the self-coupling terms of planar subdomains as well as the mutual-coupling terms of planar and vertical cells. The self-coupling submatrix due to vertical posts is calculated from the EFIE formulation since the analytic integration over the vertical basis function can alleviate the EFIE's singularity. The details of the matrix equation can be found in our previous work [10] [19].

A generalized three-dimensional (3-D) multilayered microstrip circuit is shown in Fig. 1. The medium is assumed to be infinite in the x-y plane, and the microstrip patterns are assumed to be of infinitesimal thickness. Both the upper and lower ground planes are removable to represent

either a shielded, semi-open, or open structure. Multiple vias as well as air-bridges are used to connect different microstrips. Grounded vias are also applied to achieve the short effect. The combined MPIE-EFIE methodology presented in this research meshes the whole microstrip geometry with small triangular facets. The MPIE formulation is used to evaluate the self coupling terms of planar subdomains as well as the mutual coupling between planar and vertical cells. The self coupling submatrix due to vertical posts is calculated from the EFIE formulation.

## 2. Numerical Results and Discussion

Five applications are discussed in this section. All computations are performed on the cluster system of IBM RS/6000's in the UCLA Office of Academic Computing Center.

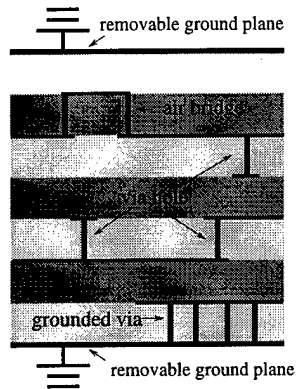


Figure 1: Generic via-hole and air-bridge transitions in a multilayered medium.

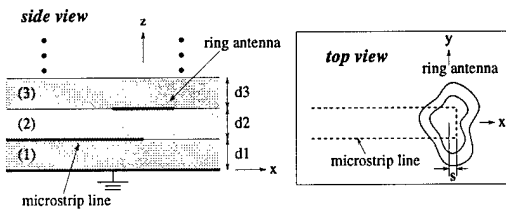
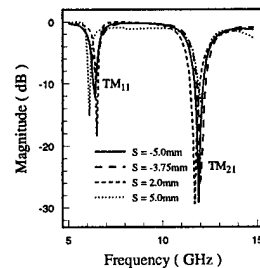
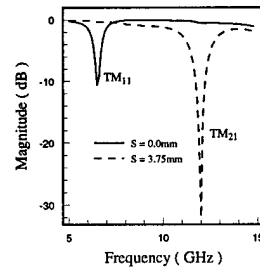


Figure 2: Arbitrary shaped ring-type antenna.



(a)



(b)

Figure 3: Return loss of a circular ring with different overlap coupling length: (a) Multiple mode excitation; (b) Single mode excitation;  $\epsilon_1 = \epsilon_2 = 2.2$ ,  $d_1 = d_2 = 0.794\text{mm}$ ,  $R_i = 3.0\text{mm}$ ,  $R_o = 7.5\text{mm}$ , feedline width =  $2.25\text{mm}$  ( $50\Omega$ ),  $S$  is the overlap length with 0 at the center of the ring.

## A. Electromagnetically-Coupled (EMC) Ring-Type Antenna

A popular type of microstrip antenna is the ring type shown in Fig. 2. To avoid the soldered probe-feed excitation, a microstrip feed line is embedded underneath to feed the ring element by electromagnetic coupling. Compared to circular disks, the ring antennas demonstrate larger bandwidth and smaller size by a proper choice of the annulus radii [21]-[24]. Fig.3 shows the return loss of an EMC circular ring antenna. The resonant frequencies of various modes and the lowest reflection will be changed by adjusting the overlap length between the feedline and the ring. Fig.3 (a) shows that most coupling lengths can excite two modes, namely  $TM_{11}$  and  $TM_{21}$  [23]-[25], but Fig.3(b) shows that for some specific lengths only one mode can be excited. This property can be exploited to design a radiator which can operate at single or multiple modes.

## B. Via-Hole Application in Antenna Design

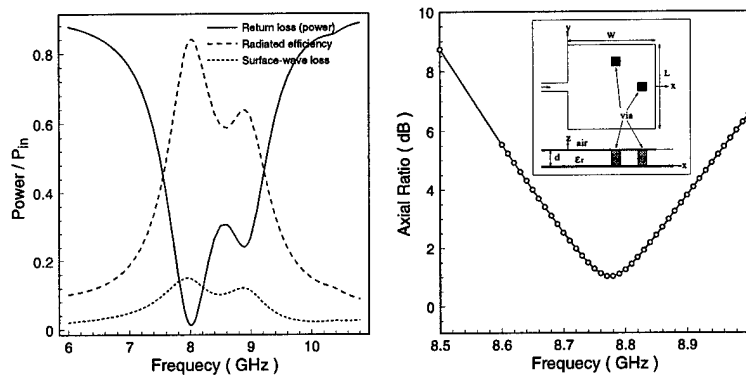


Figure 4: A grounded edge-fed rectangular patch antenna. Left: power distribution versus frequency: Right: axial ratio near 8.78 GHz. The antenna dimensions:  $d=1.575$ ,  $W=L=12.7$ , line width=1.27, via size=1.27 x 1.27, via positions: (6.985,3.81),(10.795,0.0),  $\epsilon_r=2.33$ . All units in mm.

Our second example is an edge-fed rectangular patch antenna grounded by two vias. The vias provide circular polarization and improved bandwidth by enhancing the coupling effects. The structure and analyzed results are shown in Fig.4. The planar structure is introduced in [20] with the analysis of power distribution by the spectral domain method. Addition of these vias shifts the resonant frequency from 7.2 GHz [20] to 8.0 GHz with linearly polarized radiation ( $AR > 20$  dB). This also introduces another resonance at 8.78 GHz with circularly polarized radiated field ( $AR < 1$  dB). The perturbation of the grounded vias makes the radiating element resonant along both the x and y directions.

## C. Dual-Slot Coupled Circular Patch Antenna

Our third example is a dual-slot coupled circular patch (DSCCP) antenna as shown in Fig.5. This type of antenna was proposed by Shoki *et. al.*[26] with a stripline feed. Comparison with their measured data is excellent, as demonstrated in Fig. 6 (Left). However, with a uniform microstrip feed line, an input impedance match at the center frequency is not obtained as the dashed line in

Fig.6 (Right) indicates. We design and implement a quarter-wavelength microstrip transformer to obtain a good match as the solid line in Fig.6 (Right) shows. A near 90% radiation efficiency is also obtained.

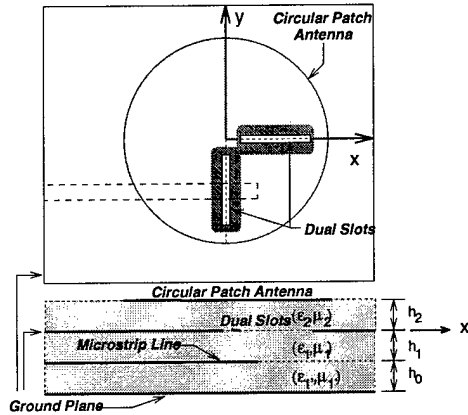


Figure 5: Configuration of a DSCCPA Antenna.

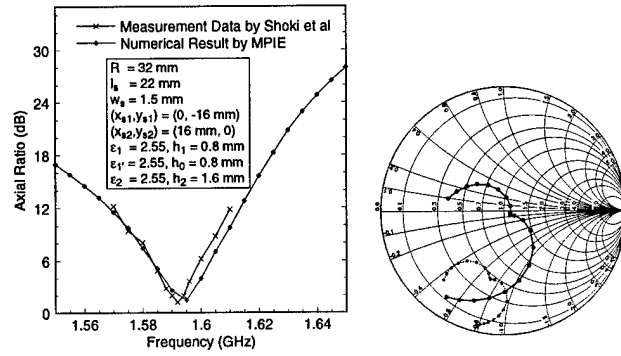


Figure 6: (Left) Comparison of axial ratio for a stripline fed DSCCP antenna between this work and [26]. (Right) Input impedance with and without a quarter wavelength transformer.

#### D. Grounded Via in an Infinite Microstrip Line

The next example is an infinite microstrip line grounded by a via, which was presented in [32] by using the planar waveguide model.

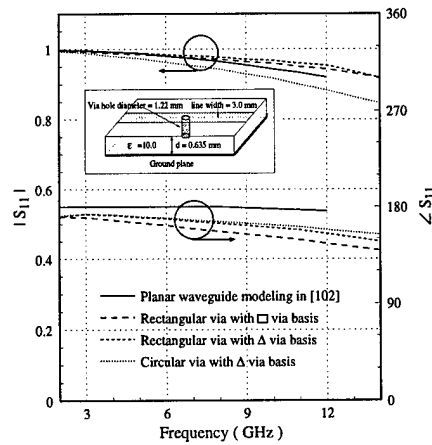


Figure 7: Magnitude and phase of  $S_{11}$  for an infinite microstrip line with ground via,  $\epsilon_r = 2.2$ , thickness = 0.635mm, line width = 3.0mm, via hole diameter = 1.22mm

The structure and analyzed results are shown in Fig.7 . Three different simulations are

investigated: 1) rectangular ground via expanded by one vertical current basis function with a rectangular cross section; 2) rectangular ground via expanded by two vertical current basis functions with triangular cross section; 3) circular ground via expanded by eight vertical current basis functions with triangular cross section. The reference plane is along the center of the ground via. All cases show that the current flows down to the ground plane, and a good short can be achieved over a broad frequency range.

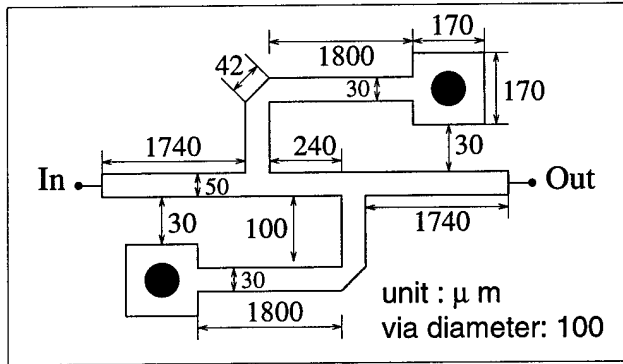


Figure 8: Geometry of bandpass filter with two via hole grounds (substrate height =  $125\mu\text{m}$  and dielectric constant = 12.9).

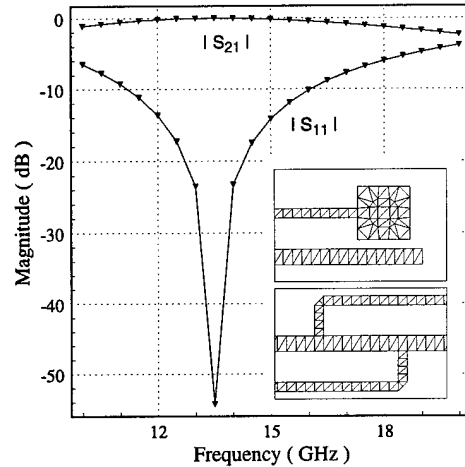


Figure 9: S-parameters of bandpass filter with two via grounds. Inset shows the triangular mesh.

### E. Vias in Filter Design

Our last example incorporates two via-hole grounds as shown in Fig.8. Two metered-bend lines with rectangular pads are connected to the main transmission line. Each pad is grounded by a circular via hole with a  $100\text{-}\mu\text{m}$  diameter. The triangular mesh is shown in the inset of Fig.9. Eighteen triangular cells are used to expand the vertical current for each via hole. The total number of unknowns is 555, and the CPU time is about 39.2 s per frequency point. Compared to 444s/freq for the Microwave Explorer 1.11 on HP730 [33], our algorithm is much more efficient. The simulated results are shown for lossless layers and perfectly conducting microstrip lines in Fig.9. The resonant frequency is predicted well as 13.5 GHz [33].

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1. George Antilla Ph.D. Electrical Engineering June 1993.
2. Ming-Ju Tsai, M.S. and Ph.D. Electrical Engineering December 1993 and June 1996 respectively.
3. Ching-Lung Chen, M.S. and Ph.D. Electrical Engineering December 1993 and June 1996 respectively.
4. Owen Fordham
5. Franco DeFlaviis
6. Raul R. Ramirez
7. William M. Merrill M.S. Electrical Engineering December 1996.

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